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May 2017

## FODM8801A, FODM8801B, FODM8801C OptoHiT<sup>™</sup> Series, High-Temperature Phototransistor Optocoupler in Half-Pitch Mini-Flat 4-Pin Package

#### Features

- Utilizing Proprietary Process Technology to Achieve High Operating Temperature: up to 125°C
- Guaranteed Current Transfer Ratio (CTR) Specifications Across Full Temperature Range
  - Excellent CTR Linearity at High-Temperature
  - CTR at Very Low Input Current, IF
- High Isolation Voltage Regulated by Safety Agency: C-UL / UL1577, 3750 VAC<sub>RMS</sub> for 1 minute and DIN EN/IEC60747-5-5
- Compact Half-Pitch, Mini-Flat, 4-Pin Package (1.27 mm Lead Pitch, 2.4 mm Maximum Standoff Height)
- > 5 mm Creepage and Clearance Distance
- Applicable to Infrared Ray Reflow, 245°C

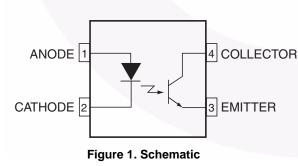
#### Applications

- Primarily Suited for DC-DC Converters
- Ground-Loop Isolation, Signal-Noise Isolation
- Communications Adapters, Chargers
- Consumer Appliances, Set-Top Boxes
- Industrial Power Supplies, Motor Control, Programmable Logic Control

### Description

In the OptoHiT<sup>™</sup> series, the FODM8801 is a first-of-kind phototransistor, utilizing Fairchild's leading-edge proprietary process technology to achieve high operating temperature characteristics, up to 125°C. The opto-coupler consists of an aluminum gallium arsenide (AlGaAs) infrared light-emitting diode (LED) optically coupled to a phototransistor, available in a compact half-pitch, mini-flat, 4-pin package. It delivers high current transfer ratio at very low input current. The input-output isolation voltage, V<sub>ISO</sub>, is rated at 3750 VAC<sub>RMS</sub>.

#### Schematic



#### Package

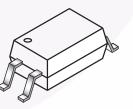


Figure 2. Half-Pitch Mini-Flat

## Safety and Insulation Ratings

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter		Characteristics
Installation Classifications per DIN VDE	< 150 V <sub>RMS</sub>	I–IV
0110/1.89 Table 1, For Rated Mains Voltage	< 300 V <sub>RMS</sub>	I–111
Climatic Classification		40/125/21
Pollution Degree (DIN VDE 0110/1.89)		2
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit
V	Input-to-Output Test Voltage, Method A, $V_{IORM} \times 1.6 = V_{PR}$ , Type and Sample Test with $t_m = 10$ s, Partial Discharge < 5 pC	848	V <sub>peak</sub>
V <sub>PR</sub>	Input-to-Output Test Voltage, Method B, $V_{IORM} \times 1.875 = V_{PR}$ , 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC	1060	V <sub>peak</sub>
V <sub>IORM</sub>	Maximum Working Insulation Voltage	565	V <sub>peak</sub>
V <sub>IOTM</sub>	Highest Allowable Over-Voltage	6000	V <sub>peak</sub>
	External Creepage	≥ 5	mm
	External Clearance	≥ 5	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥ 0.5	mm
Τ <sub>S</sub>	Case Temperature <sup>(1)</sup>	150	°C
I <sub>S,INPUT</sub>	Input Current <sup>(1)</sup>	200	mA
P <sub>S,OUTPUT</sub>	Output Power <sup>(1)</sup>	300	mW
R <sub>IO</sub>	Insulation Resistance at $T_S$ , $V_{IO} = 500 V^{(1)}$	> 10 <sup>9</sup>	Ω

#### Note:

1. Safety limit values - maximum values allowed in the event of a failure.

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.  $T_A = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Value	Unit
Total Package			
T <sub>STG</sub>	Storage Temperature	-40 to +150	°C
T <sub>OPR</sub>	Operating Temperature	-40 to +125	°C
TJ	Junction Temperature	-40 to +140	°C
T <sub>SOL</sub>	Lead Solder Temperature	245 for 10 s	°C
Emitter			
I <sub>F(average)</sub>	Continuous Forward Current	20	mA
V <sub>R</sub>	Reverse Input Voltage	6	V
PD <sub>LED</sub>	Power Dissipation <sup>(2)(4)</sup>	40	mW
Detector			
I <sub>C(average)</sub>	Continuous Collector Current	30	mA
V <sub>CEO</sub>	Collector-Emitter Voltage	75	V
V <sub>ECO</sub>	Emitter-Collector Voltage	7	V
PD <sub>C</sub>	Collector Power Dissipation <sup>(3)(4)</sup>	150	mW

Notes:

2. Derate linearly from 73°C at a rate of 0.24 mW/°C

3. Derate linearly from 73°C at a rate of 2.23 mW/°C.

4. Functional operation under these conditions is not implied. Permanent damage may occur if the device is subjected to conditions outside these ratings.

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Value	Unit
T <sub>A</sub>	Operating Temperature	-40 to +125	°C
V <sub>FL(OFF)</sub>	Input Low Voltage	-5.0 to +0.8	V
I <sub>FH</sub>	Input High Forward Current	1 to 10	mA

#### **Isolation Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>ISO</sub>	Input-Output Isolation Voltage	f = 60 Hz, t = 1 min., $I_{I\text{-}O} \leq 10 \ \mu A^{(5)(6)}$	3,750			VAC <sub>RMS</sub>
R <sub>ISO</sub>	Isolation Resistance	$V_{I-O} = 500 V^{(5)}$	10 <sup>12</sup>			Ω
C <sub>ISO</sub>	Isolation Capacitance	f = 1 MHz		0.3	0.5	pF

#### Notes:

5. Device is considered a two-terminal device: pins 1 and 2 are shorted together and pins 3 and 4 are shorted together. 6.3,750 VAC<sub>RMS</sub> for 1 minute is equivalent to 4,500 VAC<sub>RMS</sub> for 1 second.

## **Electrical Characteristics**

Apply over all recommended conditions (T<sub>A</sub> = -40°C to +125°C unless otherwise specified). All typical values are measured at T<sub>A</sub> = 25°C.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Emitter						
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 1 mA	1.00	1.35	1.80	V
$\Delta V_F / \Delta T_A$	Forward-Voltage Coefficient	I <sub>F</sub> = 1 mA		-1.6		mV / °C
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 6 V			10	μA
CT	Terminal Capacitance	V = 0 V, f = 1 MHz		30		pF
Detector						
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 0.5 mA, I <sub>F</sub> = 0 mA	75	130		V
BV <sub>ECO</sub>	Emitter-Collector Breakdown Voltage	I <sub>E</sub> = 100 μA, I <sub>F</sub> = 0 mA	7	12		V
		$V_{CE} = 75 \text{ V}, \text{ I}_{F} = 0 \text{ mA},$ $T_{A} = 25^{\circ}\text{C}$			100	nA
ICEO	Collector Dark Current	$V_{CE} = 50 \text{ V}, I_{F} = 0 \text{ mA}$			50	μA
		$V_{CE} = 5 \text{ V}, I_F = 0 \text{ mA}$			30	μA
C <sub>CE</sub>	Capacitance	V <sub>CE</sub> = 0 V, f = 1 MHz		8		pF

### **Transfer Characteristics**

Apply over all recommended conditions ( $T_A = -40^{\circ}C$  to  $+125^{\circ}C$  unless otherwise specified). All typical values are measured at  $T_A = 25^{\circ}C$ .

Symbol	Parameter	Device	Conditions	Min.	Тур.	Max.	Unit
			$I_F = 1.0 \text{ mA}, V_{CE} = 5 \text{ V}$ @ $T_A = 25^{\circ}\text{C}$	80	120	160	
		FODM8801A	I <sub>F</sub> = 1.0 mA, V <sub>CE</sub> = 5 V	35	120	230	
			I <sub>F</sub> = 1.6 mA, V <sub>CE</sub> = 5 V	40	125		
			I <sub>F</sub> = 3.0 mA, V <sub>CE</sub> = 5 V	45	138		
			$I_F = 1.0 \text{ mA}, V_{CE} = 5 \text{ V}$ @ $T_A = 25^{\circ}\text{C}$	130	195	260	
CTR <sub>CE</sub>	Current Transfer Ratio	FODM8801B	I <sub>F</sub> = 1.0 mA, V <sub>CE</sub> = 5 V	65	195	360	%
	(Collector-Emitter)		I <sub>F</sub> = 1.6 mA, V <sub>CE</sub> = 5 V	70	202		
			I <sub>F</sub> = 3.0 mA, V <sub>CE</sub> = 5 V	75	215		
			$I_F = 1.0 \text{ mA}, V_{CE} = 5 \text{ V}$ @ $T_A = 25^{\circ}\text{C}$	200	300	400	
		FODM8801C	I <sub>F</sub> = 1.0 mA, V <sub>CE</sub> = 5 V	100	300	560	
			I <sub>F</sub> = 1.6 mA, V <sub>CE</sub> = 5 V	110	312		
			I <sub>F</sub> = 3.0 mA, V <sub>CE</sub> = 5 V	115	330		
			$I_F = 1.0 \text{ mA}, V_{CE} = 0.4 \text{ V}$ @ $T_A = 25^{\circ}\text{C}$	65	108	150	
		FODM8801A	I <sub>F</sub> = 1.0 mA, V <sub>CE</sub> = 0.4 V	30	108		
			$I_{\rm F}$ = 1.6 mA, $V_{\rm CE}$ = 0.4 V	25	104		
			$I_{\rm F}$ = 3.0 mA, $V_{\rm CE}$ = 0.4 V	20	92		
			$I_F = 1.0 \text{ mA}, V_{CE} = 0.4 \text{ V}$ @ $T_A = 25^{\circ}\text{C}$	90	168	245	%
CTR <sub>CE(SAT)</sub>	Saturated Current Transfer Ratio	FODM8801B	I <sub>F</sub> = 1.0 mA, V <sub>CE</sub> = 0.4 V	45	168		
· · ·	(Collector-Emitter)		$I_{\rm F}$ = 1.6 mA, $V_{\rm CE}$ = 0.4 V	40	155		
			$I_{\rm F}$ = 3.0 mA, $V_{\rm CE}$ = 0.4 V	35	132		
			$I_F = 1.0 \text{ mA}, V_{CE} = 0.4 \text{ V}$ @ $T_A = 25^{\circ}\text{C}$	140	238	380	
		FODM8801C	$I_{\rm F}$ = 1.0 mA, $V_{\rm CE}$ = 0.4 V	75	238		
			I <sub>F</sub> = 1.6 mA, V <sub>CE</sub> = 0.4 V	65	215		
			$I_F = 3.0 \text{ mA}, V_{CE} = 0.4 \text{ V}$	55	177		
			I <sub>F</sub> = 1.0 mA, I <sub>C</sub> = 0.3 mA		0.17	0.40	
		FODM8801A	I <sub>F</sub> = 1.6 mA, I <sub>C</sub> = 0.4 mA		0.16	0.40	
			$I_F = 3.0 \text{ mA}, I_C = 0.6 \text{ mA}$		0.15	0.40	
			I <sub>F</sub> = 1.0 mA, I <sub>C</sub> = 0.45 mA		0.17	0.40	
V <sub>CE(SAT)</sub>	Saturation Voltage	FODM8801B	I <sub>F</sub> = 1.6 mA, I <sub>C</sub> = 0.6 mA		0.16	0.40	V
			I <sub>F</sub> = 3.0 mA, I <sub>C</sub> = 1.0 mA		0.16	0.40	
			I <sub>F</sub> = 1.0 mA, I <sub>C</sub> = 0.75 mA		0.18	0.40	
		FODM8801C	I <sub>F</sub> = 1.6 mA, I <sub>C</sub> = 1.0 mA		0.17	0.40	
			I <sub>F</sub> = 3.0 mA, I <sub>C</sub> = 1.6 mA		0.17	0.40	

## **Switching Characteristics**

Apply over all recommended conditions (T<sub>A</sub> = -40°C to +125°C unless otherwise specified). All typical values are measured at T<sub>A</sub> = 25°C.

Symbol	Parameter	Device	Conditions	Min.	Тур.	Max.	Unit
tou	Turn-On Time	All Devices	$I_{\rm F} = 1.6 \text{ mA}, \text{ V}_{\rm CC} = 5 \text{ V},$ $R_{\rm L} = 0.75 \text{ k}\Omega$	1	6	20	110
t <sub>ON</sub>		All Devices	$I_{F} = 1.6 \text{ mA}, \text{ V}_{CC} = 5 \text{ V},$ $R_{L} = 4.7 \text{ k}\Omega$		6		μs
t <sub>OFF</sub>	Turn-Off Time	All Devices	$I_F$ = 1.6 mA, V <sub>CC</sub> = 5 V, R <sub>L</sub> = 0.75 kΩ	1	6	20	μs
'OFF		All Devices	$I_{F} = 1.6 \text{ mA}, \text{ V}_{CC} = 5 \text{ V},$ $R_{L} = 4.7 \text{ k}\Omega$		40		μο
t <sub>R</sub>	Output Rise Time (10% to 90%)	All Devices	$I_F$ = 1.6 mA, V <sub>CC</sub> = 5 V, R <sub>L</sub> = 0.75 kΩ		5		μs
t <sub>F</sub>	Output Fall Time (90% to 10%)	All Devices	$I_F$ = 1.6 mA, V <sub>CC</sub> = 5 V, R <sub>L</sub> = 0.75 kΩ		5.5		μs
CM <sub>H</sub>	Common-Mode Rejection Voltage (Transient Immunity) – Output High	All Devices	$\begin{split} &T_{A} = 25^{\circ}C, \ I_{F} = 0 \ mA, \\ &V_{O} > 2.0 \ V, \ R_{L} = 4.7 \ k\Omega, \\ &V_{CM} = 1000 \ V^{(7)}, \\ &Figure 16 \end{split}$		20		kV / μs
CML	Common-Mode Rejection Voltage (Transient Immunity) – Output Low	All Devices	$\begin{split} &T_{A} = 25^{\circ}C, \ I_{F} = 1.6 \ mA, \\ &V_{O} < 0.8 \ V, \ R_{L} = 4.7 \ k\Omega, \\ &V_{CM} = 1000 \ V^{(7)}, \\ &Figure 16 \end{split}$		20		kV / μs

#### Note:

7.Common-mode transient immunity at output high is the maximum tolerable positive dVcm/dt on the leading edge of the common-mode impulse signal,  $V_{CM}$ , to assure that the output remains high.



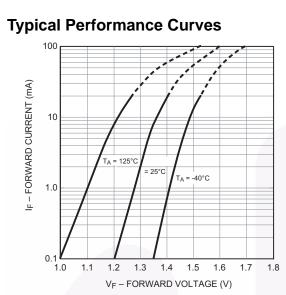


Figure 3. Forward Current vs. Forward Voltage

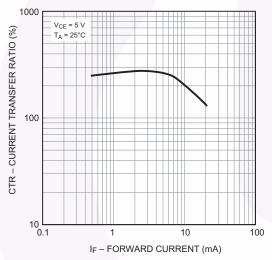
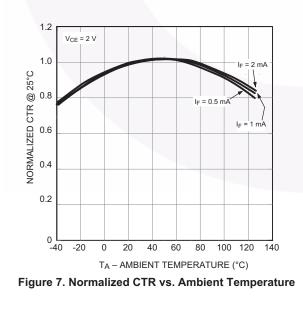


Figure 5. Current Transfer Ratio vs. Forward Current



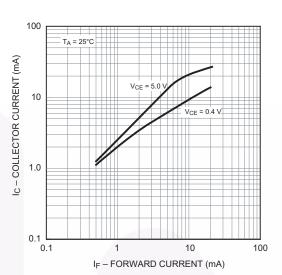


Figure 4. Collector Current vs. Forward Current

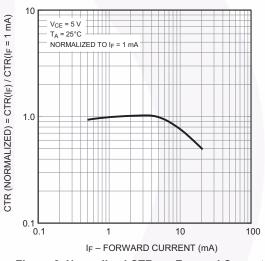
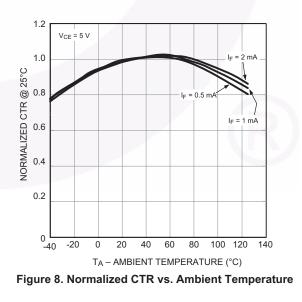
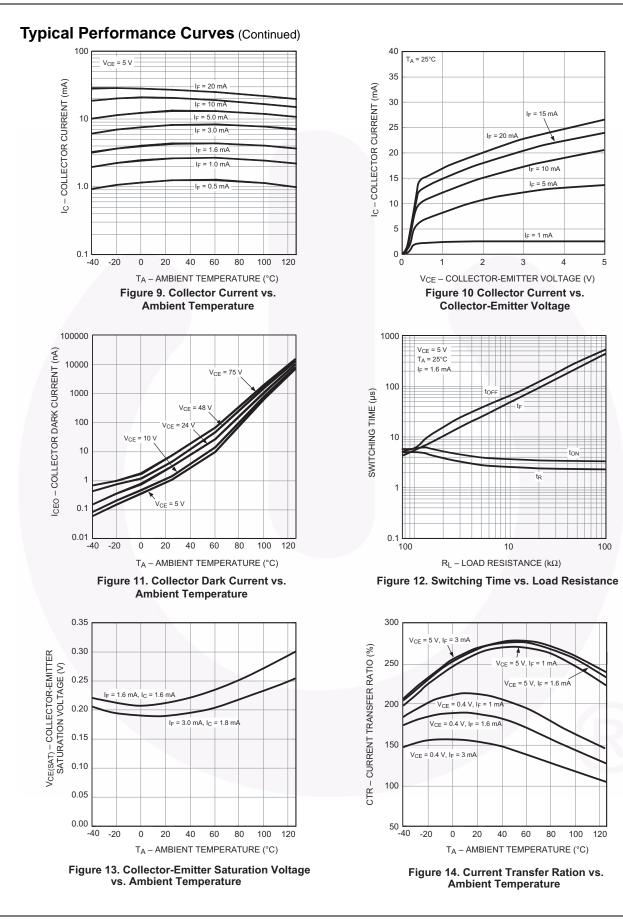
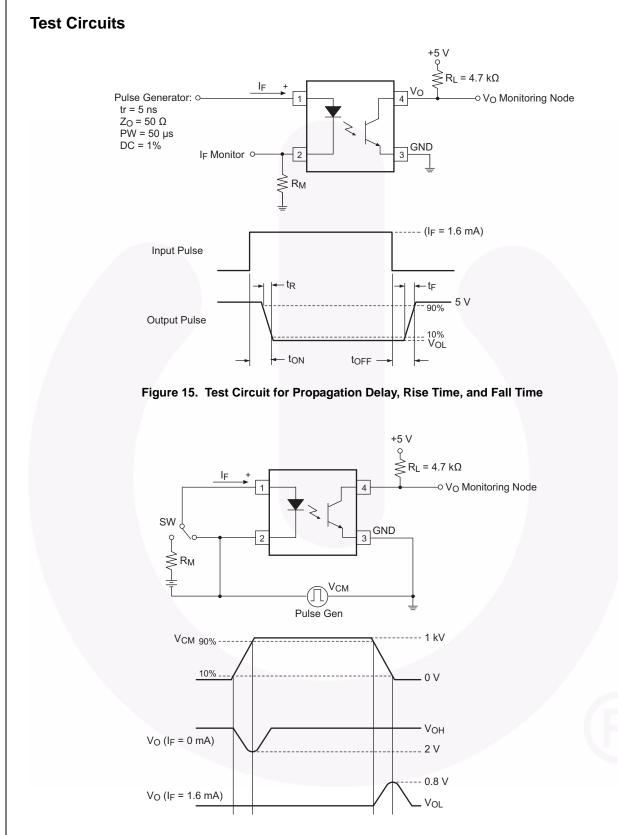


Figure 6. Normalized CTR vs. Forward Current



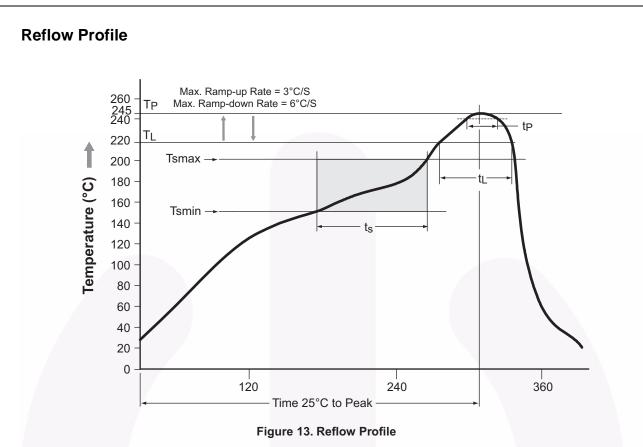
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FODM8801X — OptoHiT<sup>™</sup> Series, High-Temperature Phototransistor Optocoupler in Half-Pitch Mini-Flat 4-Pin Package



Profile Freature	Pb-Free Assembly Profile	
Temperature Minimum (Tsmin)	150°C	
Temperature Maximum (Tsmax)	200°C	
Time (t <sub>S</sub> ) from (Tsmin to Tsmax)	60–120 seconds	
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second maximum	
Liquidous Temperature (T <sub>L</sub> )	217°C	
Time $(t_L)$ Maintained Above $(T_L)$	60–150 seconds	
Peak Body Package Temperature	245°C +0°C / -5°C	
Time (t <sub>P</sub> ) within 5°C of 245°C	30 seconds	
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second maximum	
Time 25°C to Peak Temperature	8 minutes maximum	

Figure 17. Reflow Profile

### **Ordering Information**

Part Number	Package	Packing Method
FODM8801A	Half Pitch Mini-Flat 4-Pin	Tube (100 units)
FODM8801AR2	Half Pitch Mini-Flat 4-Pin	Tape and Reel (2500 Units)
FODM8801AV	Half Pitch Mini-Flat 4-Pin, DIN EN/IEC60747-5-5 Option	Tube (100 Units)
FODM8801AR2V	Half Pitch Mini-Flat 4-Pin, DIN EN/IEC60747-5-5 Option	Tape and Reel (2500 Units)

#### Note:

8. The product orderable part number system listed in this table also applies to the FODM8801B, FODM8801C products.

## **Marking Information**

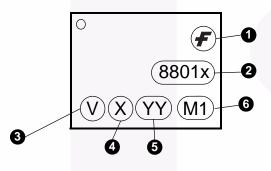
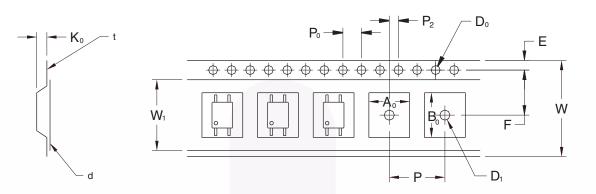


Figure 18. Top Mark

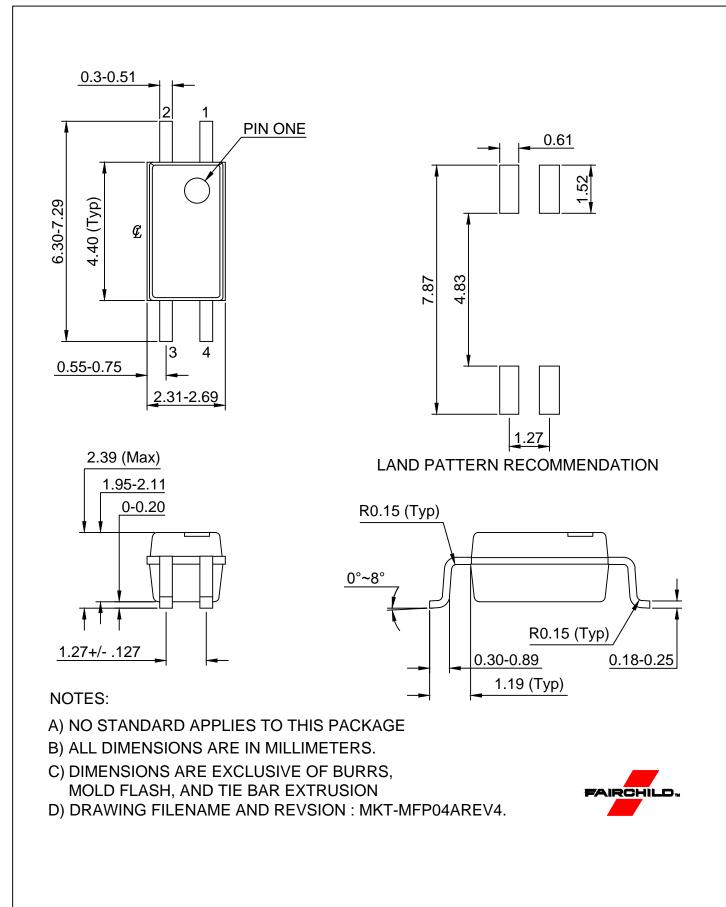
#### Table 1. Top Mark Definitions

1	Fairchild Logo
2	Device Number
3	DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)
4	One-Digit Year Code, e.g., "6"
5	Digit Work Week, Ranging from "01" to "53"
6	Assembly Package Code

## **Tape and Reel Dimensions**



		ſ	1.27 Pitch
D	escription	Symbol	Dimensions (mm)
Tape Width		W	12.00 +0.30/-0.10
Tape Thickness		t	0.30 ±0.05
Sprocket Hole Pitch		P <sub>0</sub>	4.00 ±0.10
Sprocket Hole Diameter	er	D <sub>0</sub>	1.50 +0.10/-0.0
Sprocket Hole Location	n	E	1.75 ±0.10
Pocket Location		F	5.50 ±0.10
		P <sub>2</sub>	2.00 ±0.10
Pocket Pitch		Р	8.00 ±0.10
Pocket Dimension		A <sub>0</sub>	2.80 ±0.10
		B <sub>0</sub>	7.30 ±0.10
		K <sub>0</sub>	2.30 ±0.10
Pocket Hole Diameter		D <sub>1</sub>	1.50 Min.
Cover Tape Width		W1	9.20
Cover Tape Thickness	i	d	0.065 ±0.010
Max. Component Rota	tion or Tilt		10° Max.
Devices Per Reel			2500
Reel Diameter			330 mm (13")



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